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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

PRELIMINARY AMENDMENT ACCOMPANYING SUBMISSION OF MISSING PARTS

APPLICANT: Akira Yoshizawa, et al. ATTY. DOCKET NO. 09792909-5237

SERIAL NO.

DATE FILED:

INVENTION: "SEMICONDUCTOR DEVICE USING INTERPOSER SUBSTRATE AND MANUFACTURING METHOD THEREFOR"

Assistant Commissioner of Patents
Washington, D.C. 20231

S I R:

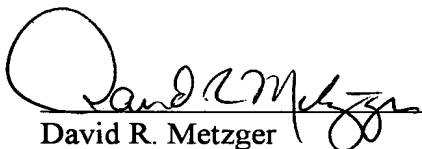
Applicants submit this Preliminary Amendment for consideration in the above-identified patent application:

IN THE SPECIFICATION

At page 10, line 16, change "Figs. 4A to 4F" to --Figs. 4A to 4J--.

204720" E6502660

Respectfully submitted,

 (Reg. No. 32,919)

David R. Metzger
SONNENSCHN NATH & ROSENTHAL
P.O. Box #061080
Wacker Drive Station
Sears Tower
Chicago, IL 60606-1080
Customer #26263

Attorneys for Applicant(s)